

1. DESCRIPTION

The XL236-2.5 and XL/XT336-2.5 integrated circuits are precision 2.5V shunt regulator diodes. These monolithic IC voltage references operate as a low-temperature-coefficient 2.5V zener with 0.2Ω dynamic impedance.

2. FEATURES

- Low Temperature Coefficient
- Wide Operating Current of 400 μA to 10 mA
- 0.2Ω Dynamic Impedance
- ±1% Initial Tolerance Available
- Specified Temperature Stability
- Easily Trimmed for Minimum Temperature Drift
- Fast Turn-On

3. CONNECTION DIAGRAM

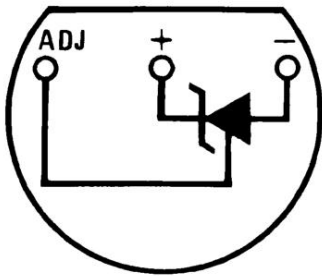


Figure 1.TO-92 Plastic Package
(Bottom View)

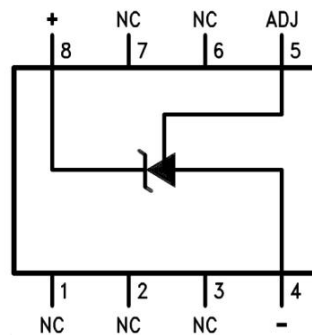
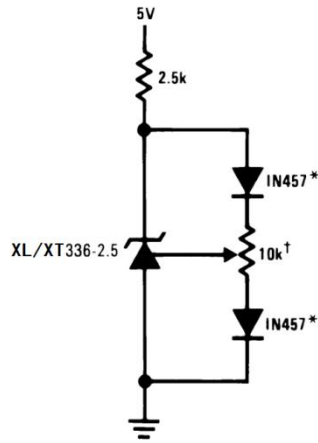


Figure 2. SOP 8 Package

4. TYPICAL APPLICATIONS



[†]Adjust to 2.490V

*Any silicon signal diode

Figure 3. 2.5V Reference with Minimum Temperature Coefficient

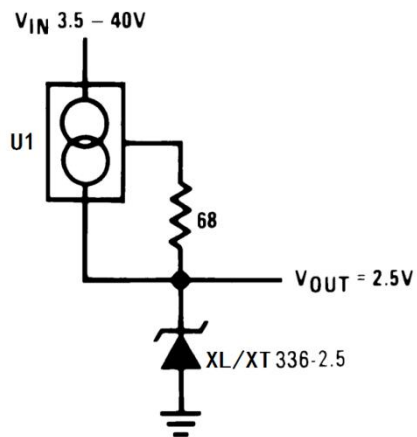


Figure 4. Wide Input Range Reference

Note 1: U1 uses a constant current source IC, such as an LM334 or equivalent.

5. ABSOLUTE MAXIMUM RATINGS⁽¹⁾⁽²⁾

Reverse Current		15 mA	
Forward Current		10 mA	
Storage Temperature		−60°C to +150°C	
Operating Temperature Range	XL236	−40°C to +85°C	
	XL/XT336	−40°C to +85°C	
Soldering Information	TO-92 Package (10 sec.)		260°C
	SOP Package	Vapor Phase (60 sec.)	215°C
		Infrared (15 sec.)	220°C

(1) Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Electrical specifications do not apply when operating the device beyond its specified operating conditions.

6. THERMAL CHARACTERISTICS

Thermal Resistance	TO-92	SOP
θ_{ja} (Junction to Ambient)	180°C/W (0.4" leads)	165°C/W
	170°C/W (0.125" lead)	
θ_{ja} (Junction to Case)	n/a	n/a

7. ELECTRICAL CHARACTERISTICS⁽¹⁾

Parameter	Conditions		XL236-2.5			XL/XT336-2.5			Units
			Min	Typ	Max	Min	Typ	Max	
Reverse Breakdown Voltage	$T_A=25^\circ\text{C}$, $I_R=1\text{ mA}$	XL236,XL/XT336	2.440	2.490	2.540	2.390	2.490	2.590	V
Reverse Breakdown Change With Current	$T_A=25^\circ\text{C}$, $400\text{ }\mu\text{A}\leq I_R\leq 10\text{ mA}$			2.6	6		2.6	10	mV
Reverse Dynamic Impedance	$T_A=25^\circ\text{C}$, $I_R=1\text{ mA}$, $f=100\text{ Hz}$			0.2	0.6		0.2	1	Ω
Temperature Stability ⁽²⁾	V_R Adjusted to 2.490V $I_R=1\text{ mA}$	$0^\circ\text{C}\leq T_A\leq 70^\circ\text{C}$ (XL/XT336)					1.8	6	mV
		$-25^\circ\text{C}\leq T_A\leq +85^\circ\text{C}$ (XL236)		7.5	18				mV
Reverse Breakdown Change With Current	$400\text{ }\mu\text{A}\leq I_R\leq 10\text{ mA}$			3	10		3	12	mV
Reverse Dynamic Impedance	$I_R=1\text{ mA}$			0.4	1		0.4	1.4	Ω
Long Term Stability	$T_A=25^\circ\text{C}\pm 0.1^\circ\text{C}$, $I_R=1\text{ mA}$, $t=1000\text{ hrs}$			20			20		ppm

(1) Unless otherwise specified, the XL/XT336-2.5-N from $-40^\circ\text{C}\leq T_A\leq +85^\circ\text{C}$.

(2) Temperature stability for the XL/XT336 family is specified by design. Design limits are ensured (but not 100% production tested) over the indicated temperature and supply voltage ranges. These limits are not used to calculate outgoing quality levels. Stability is defined as the maximum change in V_{ref} from 25°C to T_A (min) or T_A (max).

8. TYPICAL PERFORMANCE CHARACTERISTICS

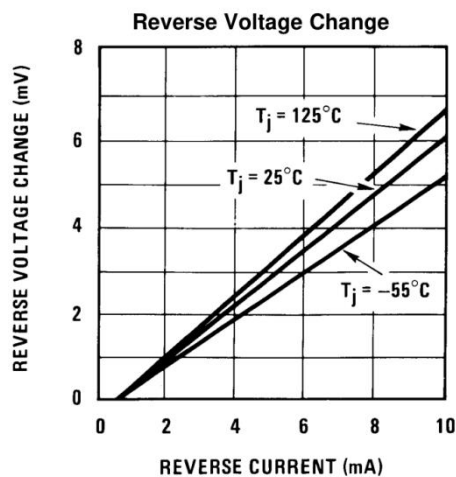


Figure 5.

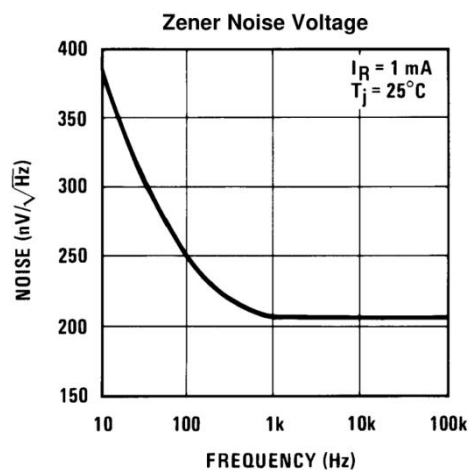


Figure 6.

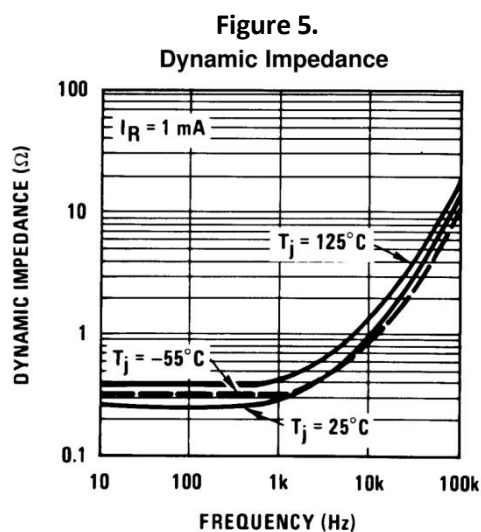


Figure 7.

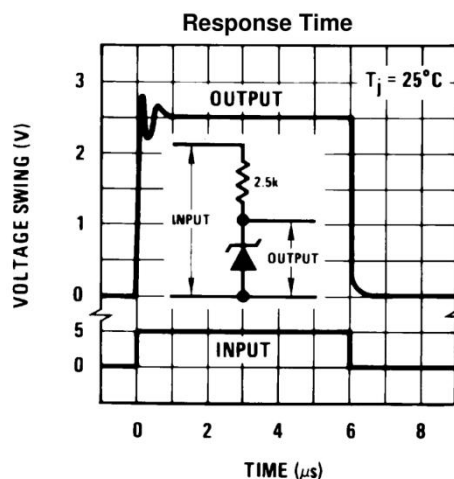


Figure 8.

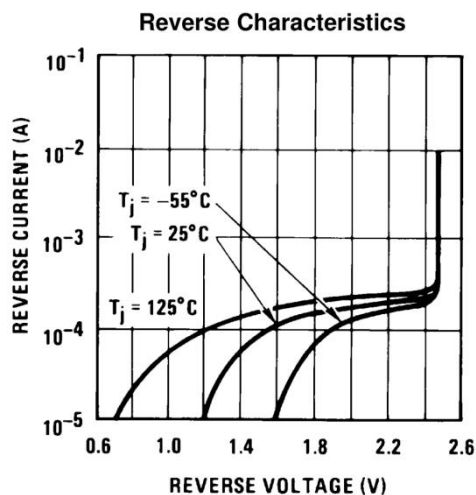


Figure 9.

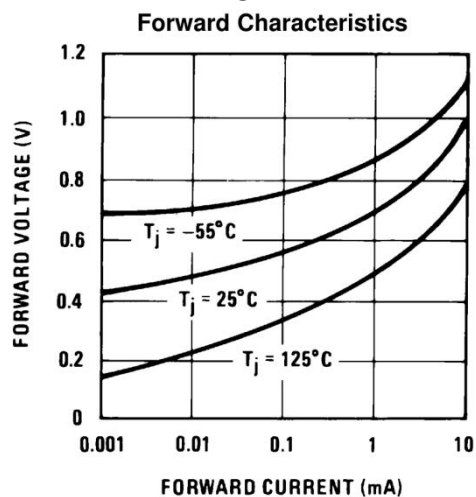


Figure 10.

TYPICAL PERFORMANCE CHARACTERISTICS(continued)

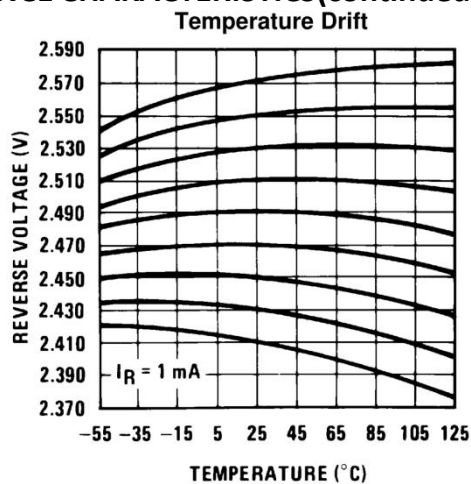


Figure 11.

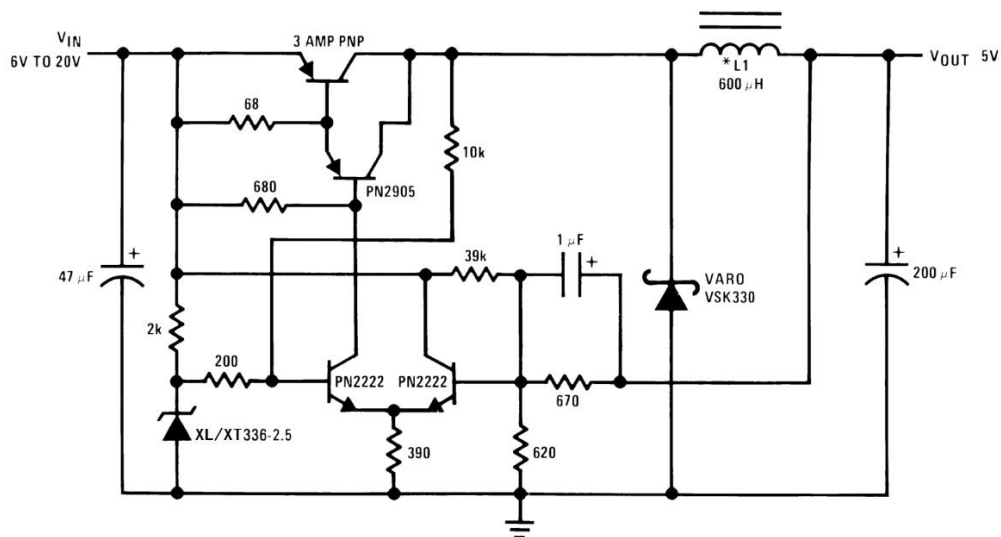


Figure 12. Low Cost 2 Amp Switching Regulator

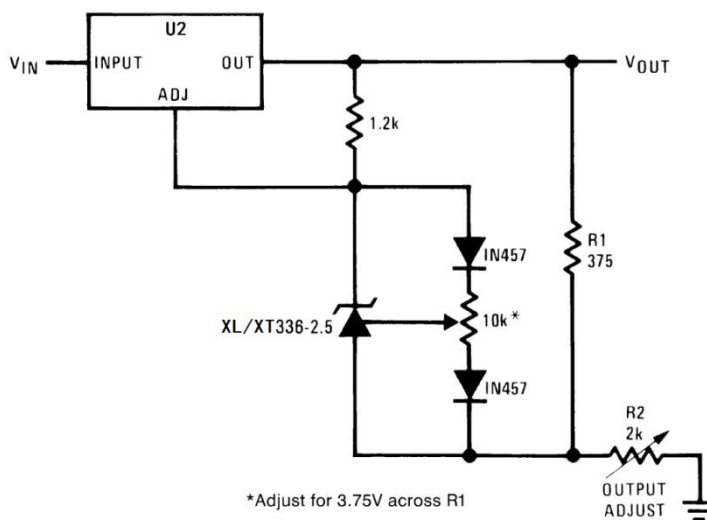


Figure 13. Precision Power Regulator with Low Temperature Coefficient

Note 2: U2 uses a constant current source IC, such as an X L 3 1 7 or equivalent.

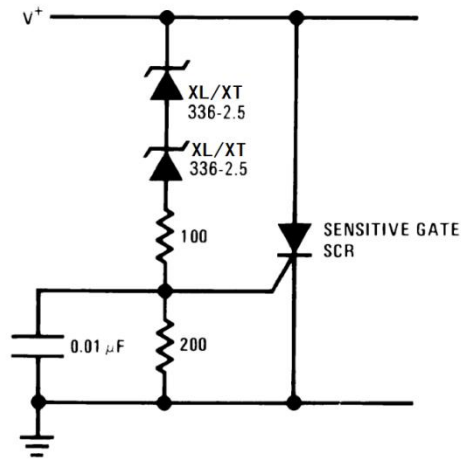
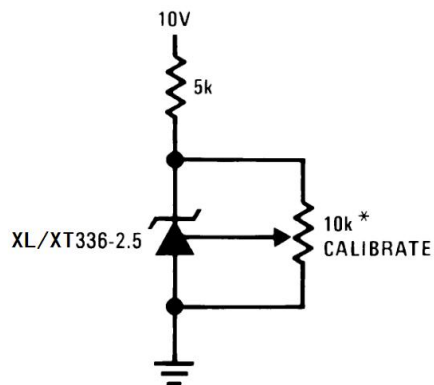


Figure 14.5V Crowbar



* Does not affect temperature coefficient

Figure 15. Trimmed 2.5V Reference with Temperature Coefficient Independent of Breakdown Voltage

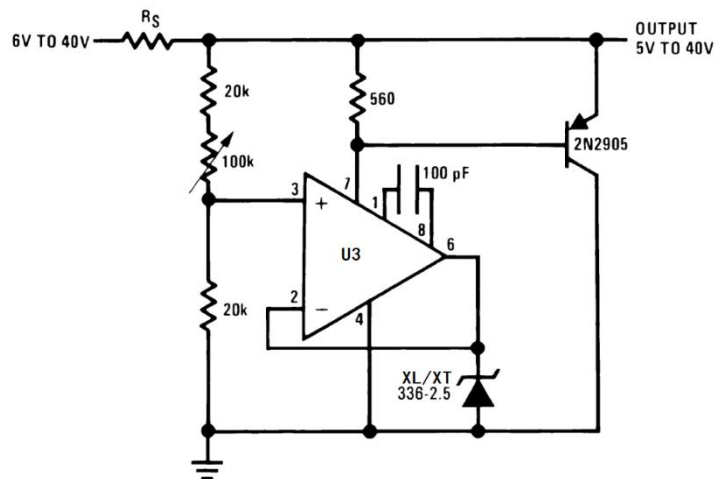


Figure 16. Adjustable Shunt Regulator

Note 3: U3 uses a constant current source IC, such as an LM308A or equivalent.

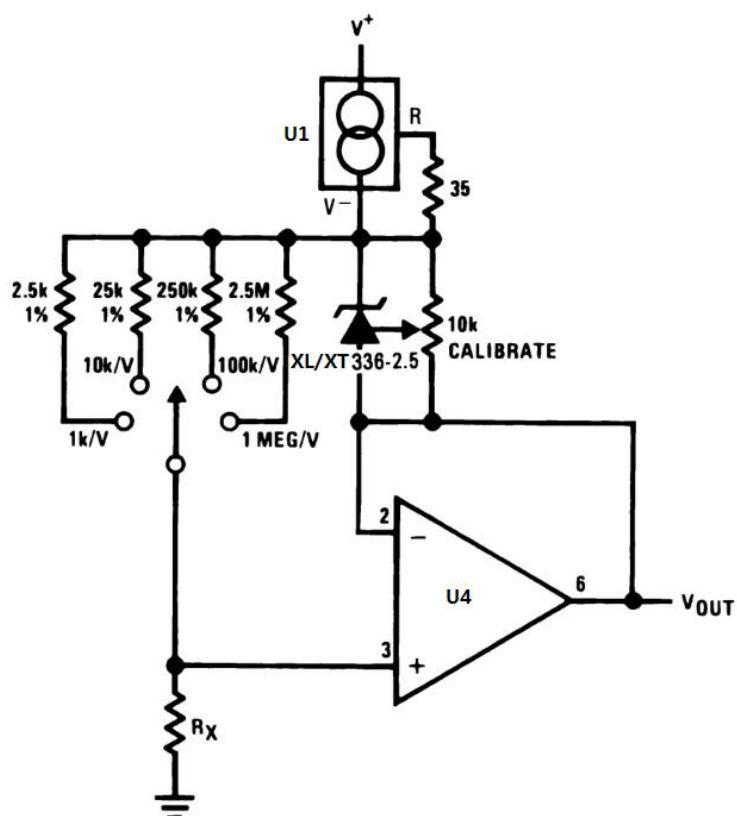


Figure 17.Linear Ohmmeter

Note 4: U4 uses a constant current source IC, such as an LM312 or equivalent.

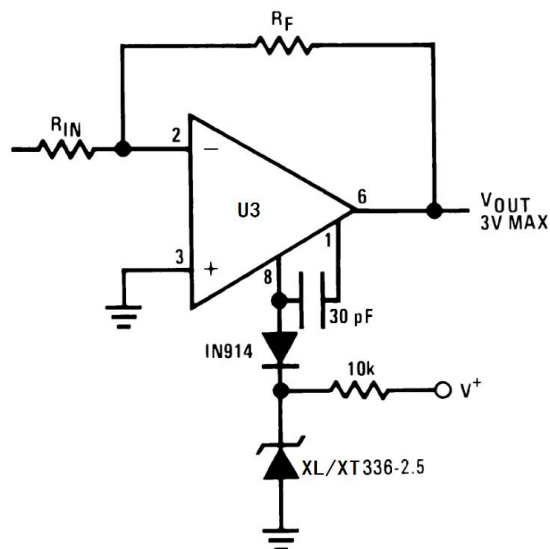


Figure 18. Op Amp with Output Clamped

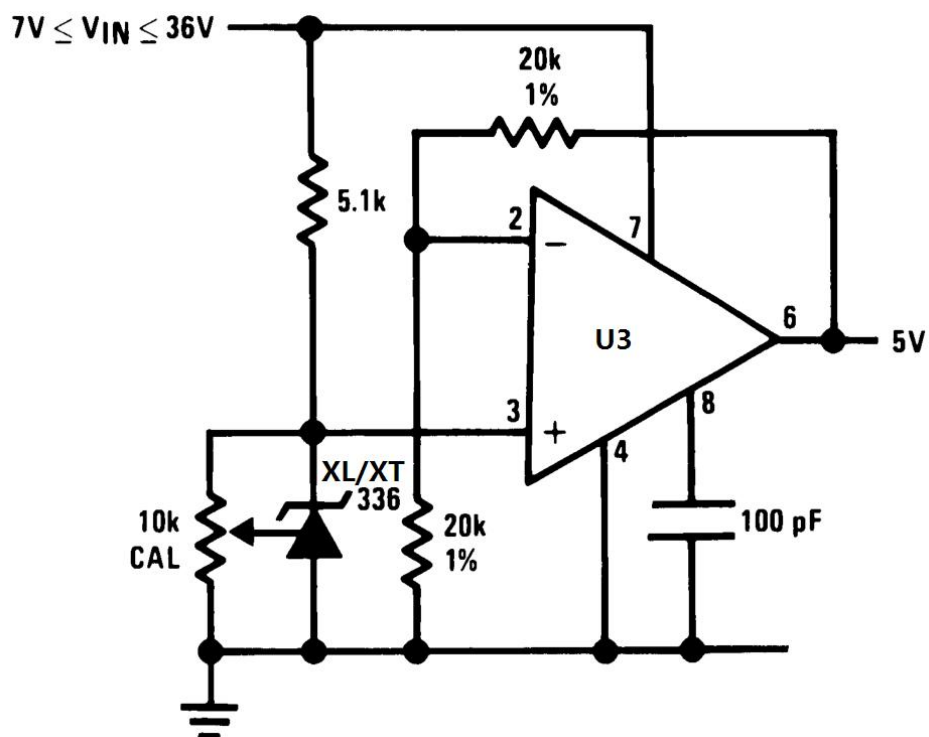


Figure 19.10V Buffered Reference

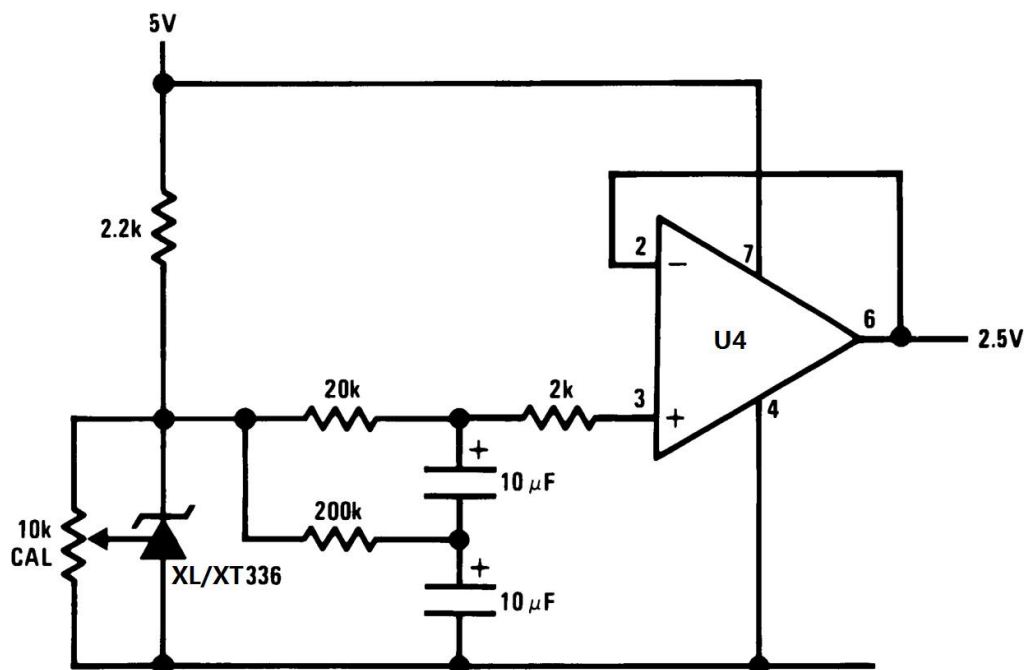
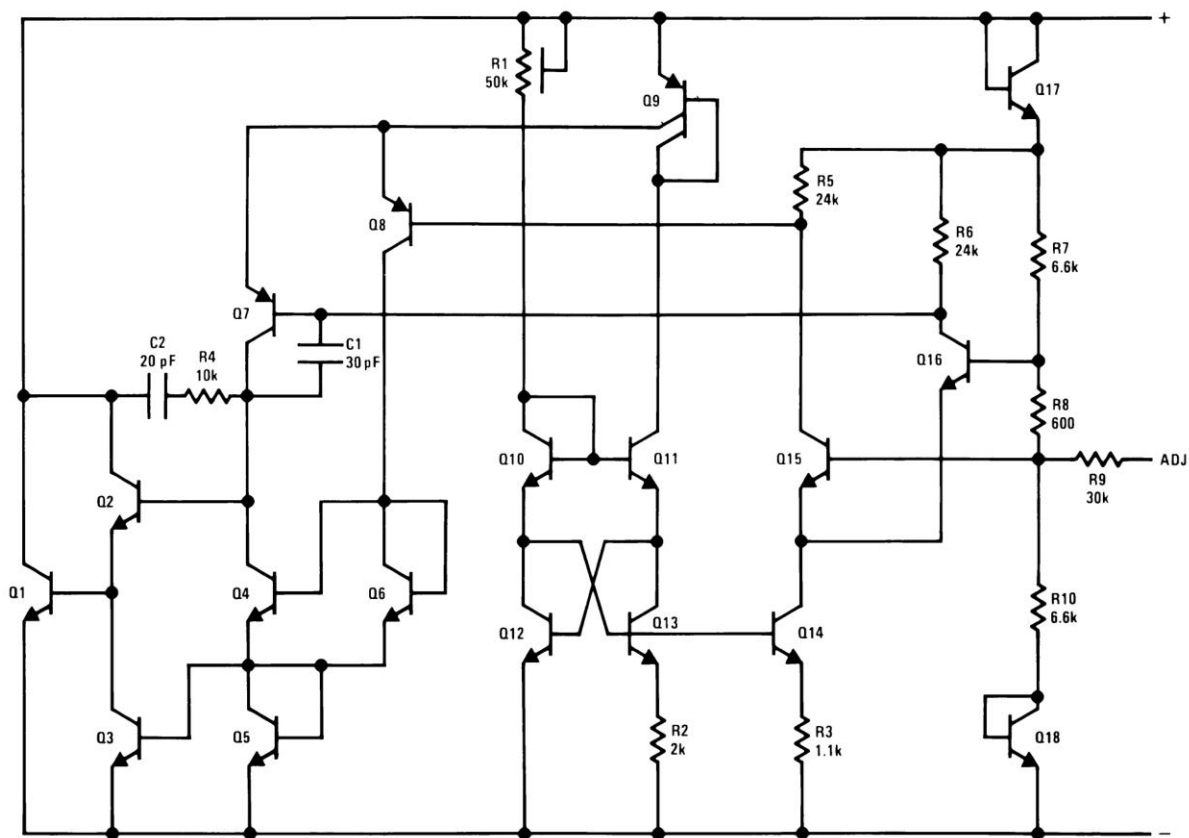


Figure 20.Low Noise Buffered Reference

9. SCHEMATIC DIAGRAM

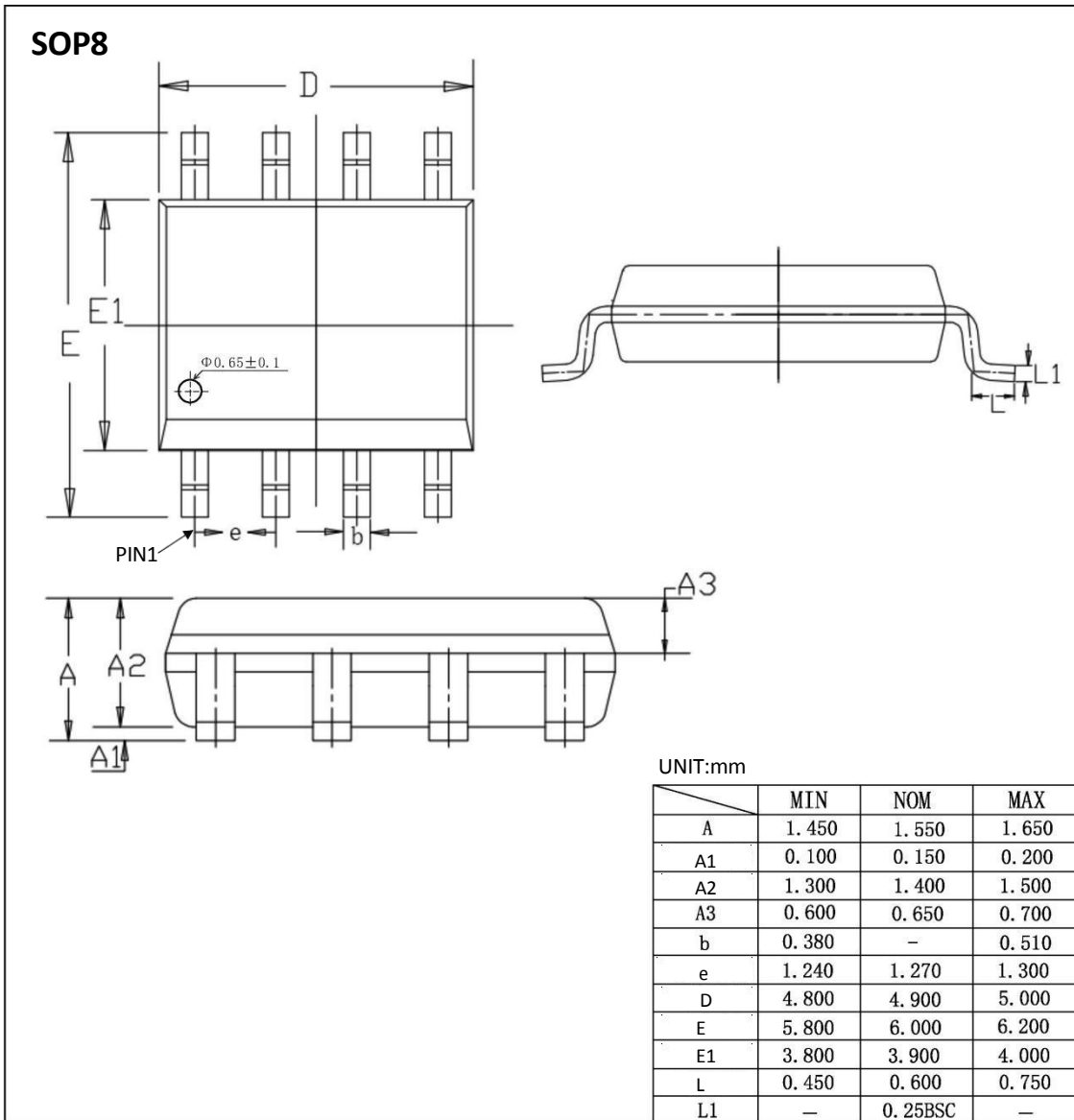


10. ORDERING INFORMATION

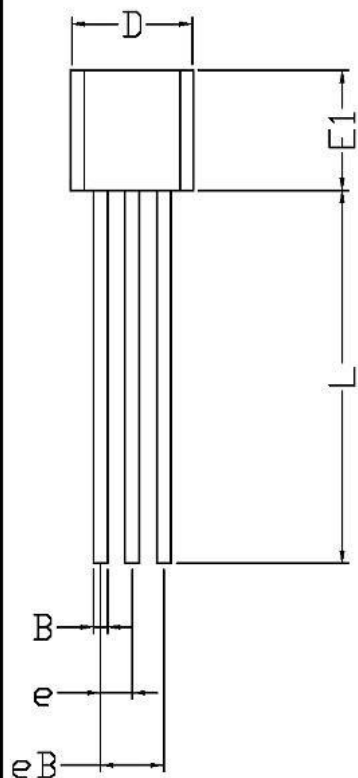
Ordering Information

Part Number	Device Marking	Package Type	Body size (mm)	Temperature (°C)	MSL	Transport Media	Package Quantity
XL336-2.5	XL336-2.5	SOP8	4.90 * 3.90	- 40 to 85	MSL3	T&R	2500
XT336-2.5	XT336-2.5	TO-92	4.58 * 4.58	- 40 to 85	MSL3	T&R	1000
XL236-2.5	XL236-2.5	SOP8	4.90 * 3.90	- 40 to 85	MSL3	T&R	2500

11. DIMENSIONAL DRAWINGS



TO-92



SYMBOL	MIN	MAX
A	3.46	3.96
A1	1.02 TYP	
B	0.36	0.56
C	1.80 TYP	
D	4.33	4.83
E1	4.33	4.83
E	3.35	3.85
eB	2.54 TYP	
e	1.27 TYP	
L	13.97	14.97

UNIT: mm

